



Call for Papers

IMPORTANT DATES

Paper Submission deadline: **June 30th, 2026**

Acceptance Notification: **July 15th, 2026**

Final Submission and registration: **Aug 15th, 2026**



IECON 2026 is the 52nd Annual Conference of the IEEE Industrial Electronics Society (IES), focusing on contemporary industry topics ranging from power electronics, power systems, controls, manufacturing, to computational intelligence and communications. IECON is the flagship annual conference of IES. It aims to create a forum for scientists and practicing engineers throughout the world to present the latest research findings and ideas in the areas of Industrial Electronics, and possible contributions toward sustainable development and environment preservation. To ensure broad global participation, IECON 2026 will take place from **18 to 21 October 2026** as a **hybrid conference**, offering both in-person and online presentation options. All accepted papers will be fully integrated into the technical program, regardless of presentation mode. The objectives of the conference are to provide high quality research and professional interactions for the advancement of science, technology, and fellowship. Papers with new research results are encouraged for submission.

Regular Sessions: The regular sessions are covered but not limited to the following:

- Power Systems and Smart Grid
- Power Electronics Converters
- Electric Machines and Industrial Drives
- Renewable Energy and Energy Storage Systems
- Resilient Control Architectures for Energy Systems
- Smart Building Technologies
- Transportation Electrification and Automotive Technologies
- Control Systems and Applications
- Mechatronics and Robotics
- Computational Intelligence and Signal and Image Processing
- Sensors, Actuators and Micro-Nanotechnology
- Electronic Systems on Chip and Embedded Systems
- Cyber-Physical Systems and Internet of Things in Industry
- Communication for Industrial and Factory Automation
- Industrial Informatics, Cloud Computing, Big Data

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Paper Submission

Prospective authors are invited to electronically submit regular papers of their work in English language on this link <https://confcomm.ieee-ies.org/app/general/conferences/IECON26/initial-submission>. The full paper should meet the following requirements. Limitation to 6 full pages, including paper title, authors and affiliations, figures and references (maximum size 2MB). Up to 2 additional pages are allowed, each additional page incurs a fee of \$ 150 per page and a full paper can have a maximum of 8 pages including the additional pages. Authors are requested to prepare the manuscripts in the IEEE two-column format template and to translate it in PDF. No other format in the submission and in the final version can be accepted. The IEEE two-column format template can be downloaded from [link](#).

For the accepted paper to be included in IEEE Xplore® Digital Library, all of the following requirements must be satisfied: 1) Appropriate publication materials: final paper and transfer of copyright to IEEE must be submitted. 2) At least one full registration should be paid. 3) Papers must be presented at the conference. Accepted, registered, and presented papers will be IEEE copyrighted and published in the conference proceedings.



IECON 2026 Website



Paper Submission Portal

